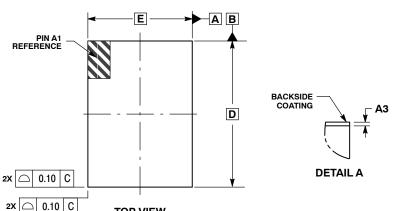


WLCSP35, 3.22x2.3 CASE 567LJ **ISSUE B**

DATE 17 MAR 2017

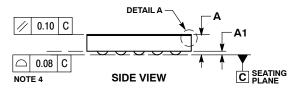


- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

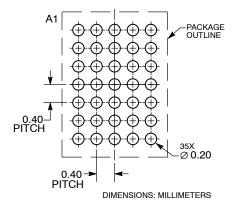
 2. CONTROLLING DIMENSION: MILLIMETERS.
- DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| | MILLIMETERS | | |
|-----|-------------|------|--|
| DIM | MIN | MAX | |
| Α | 0.35 | 0.45 | |
| A1 | 0.03 | 0.13 | |
| АЗ | 0.025 REF | | |
| b | 0.15 | 0.25 | |
| D | 3.22 BSC | | |
| E | 2.30 BSC | | |
| e | 0.40 BSC | | |



TOP VIEW

RECOMMENDED SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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| $\begin{array}{c c} \bullet & \bullet & \bullet & \bullet \\ \hline \bullet & \bullet & \bullet & \bullet & \bullet \end{array}$ |
| 1 2 3 4 5 BOTTOM VIEW |
| |

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| DESCRIPTION: | WLCSP35, 3.22X2.3 | | PAGE 1 OF 1 |

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